

## 1. SCOPE

Supply, installation and commissioning of cDAQ / equivalent Data acquisition and control system with necessary display nodes, data processing nodes, rack, power supplies, application software etc as per the details given below.

## 2. GENERAL

Two independent Data acquisition systems are required in two different test bays. Details are given below:

- a) Data acquisition and control system requirements -1

| <b>ANALOG INPUT</b>                   |                        |
|---------------------------------------|------------------------|
| <b>Input Signals</b>                  | <b>No. of Channels</b> |
| Current (4-20 mA)                     | 16                     |
| Pressure Transducer<br>(Strain gauge) | 4                      |
| TC input                              | 4                      |
| RTD input                             | 4                      |
| <b>ANALOG OUTPUT</b>                  |                        |
| <b>Signal Type</b>                    | <b>No. of Channels</b> |
| Current (4-20 mA)                     | 8                      |
| <b>DIGITAL I/O</b>                    |                        |
| <b>Type</b>                           | <b>No. of Channels</b> |
| Digital Input (24 VDC)                | 16                     |
| Digital Output (24 VDC)               | 8                      |

- b) Data acquisition and control system requirements -2

| <b>ANALOG INPUT</b>                   |                        |
|---------------------------------------|------------------------|
| <b>Input Signals</b>                  | <b>No. of Channels</b> |
| Current (4-20 mA)                     | 24                     |
| Pressure Transducer<br>(Strain gauge) | 4                      |
| TC input                              | 4                      |
| RTD input                             | 4                      |
| <b>ANALOG OUTPUT</b>                  |                        |
| <b>Signal Type</b>                    | <b>No. of Channels</b> |
| Current (4-20 mA)                     | 8                      |
| <b>DIGITAL I/O</b>                    |                        |
| <b>Type</b>                           | <b>No. of Channels</b> |
| Digital Input (24 VDC)                | 28                     |
| Digital Output (24 VDC)               | 14                     |

- a) To meet the above requirement the following subsystem to be provided accordingly.
- i. Data Acquisition Chassis
  - ii. Analog Input modules
  - iii. Analog Output modules
  - iv. Digital Input and Output modules
  - v. Data Processing Nodes
  - vi. Display Nodes
  - vii. Remote Configuration node
  - viii. Instrumentation Rack
  - ix. Software: Operating System software along with drivers and application software
  - x. Power Supplies & Relays
  - xi. Ethernet Switch
  - xii. Cables & Connectors
  - xiii. Printer
- b) Rack mountable type DIN rail/chassis based system is considered.
- c) Data acquisition system with integral signal conditioners and variable sampling rate is planned. The input signal shall be band limited and conditioned as per requirement.
- d) Software should have provision for acquisition, control, channel configuration, recording, monitoring, diagnostic and calibration of system. Two data processing nodes, two display nodes and a portable configuration system are to be provided.

### 3. SPECIFICATION CDAQ BASED

#### 3.1 Acquisition Chassis

Quantity: 2Nos.

| SL.NO | DEVICE PARAMETERS                            | REQUIRED SPECIFICATION  |
|-------|--|---|
| 1     | Number of Slots                              | 12 slot   |
| 2     | Timing Accuracy of Analog Input and output   | 50 ppm of sample rate or better   |
| 3     | clock accuracy                               | 50 ppm or better  |
| 4     | Analog Input and output Internal base clocks | 80 MHz, 20 MHz, 13.1072 MHz, 12.8 MHz, 10 MHz, 100 kHz  |
| 5     | Chassis PFI Characteristics                  |   |
|       | Maximum input or output frequency            | ≥ 1 MHz   |
| 6     | Network Interface                            | TCP/IP, UDP   |
| 7     | Bus Connector                                | Ethernet  |
| 8     | Number of Ethernet Port                      | Min. 2  |
| 9     | Communication rate                           | 10/100/1000 Mbps  |
| 10    | Power Requirements                           | 9 VDC to 30 VDC   |
| 11    | Safety Voltage                               | 30 V maximum  |
| 12    | Operating Temperature Range                  | 10 °C to 70 °C  |
| 13    | Safety Certification                         | IEC 61010-1, EN 61010-1   |
| 14    | Operating Shock                              | 30 g, 11 ms half-sine   |
| 15    | CE Compliance                                | <ul style="list-style-type: none"> <li>• 2014/35/EU; Low-Voltage Directive (safety)</li> <li>• 2014/30/EU; Electromagnetic Compatibility Directive (EMC)</li> </ul> |
| 16    | Document from Vendor                         | OEM Authorization Certificate   |

#### 3.2 Analog Input Modules

##### 3.2.1 Current

| SL.NO | DEVICE PARAMETERS                      | REQUIRED SPECIFICATION   |
|-------|--|--|
| 1     | No. of Channels                        | 16 nos. for DAQ requirement -1<br>24 nos. for DAQ requirement -2 |
| 2     | Type of ADC                            | Delta-Sigma with analog prefiltering                             |
| 3     | Analog Input Resolution                | 16 bits or better  |
| 4     | Sampling rate                          | 5Ks/s/ch or better   |
| 5     | <b>Input Signal</b>                    |  |
|       | Type                                   | Analog current   |
|       | Range                                  | 4 to 20 mA   |
| 6     | Analog Input Isolation                 | 250 Vrms ch- Earth Ground Isolation                              |
| 7     | Front Connection Type                  | Push in spring terminal  |
| 10    | Filter                                 | Butterworth, Comb  |
| 11    | Frequency of internal master time base | ≥12.8 MHz  |

|    |  |   |
|----|--|---|
| 12 | Accuracy of internal master time base                          | ±50 ppm or better   |
| 13 | Operating temperature  | 10 °C to 70 °C  |
| 14 | Overvoltage protection   | ±30 V, between any two pins of the connector  |
| 15 | Crosstalk (CH to CH)<br>$f_{in} < 100$ Hz<br>$f_{in} < 15$ kHz | 100 dB or better<br>90 dB or better   |
| 16 | Safety Certification   | IEC 61010-1, EN 61010-1   |
| 17 | Operating Shock  | 30 g, 11 ms half-sine   |
| 18 | CE Compliance  | <ul style="list-style-type: none"> <li>• 2014/35/EU; Low-Voltage Directive (safety)</li> <li>• 2014/30/EU; Electromagnetic Compatibility Directive (EMC)</li> </ul> |
| 19 | Document from Vendor   | OEM Authorization Certificate   |

### 3.2.2 Pressure Transducer (Strain Gauge) Module

| SL.NO | DEVICE PARAMETERS                                 | REQUIRED SPECIFICATION   |
|-------|---|--|
| 1     | No. of Channels                                   | 4 nos. for DAQ requirement -1<br>4 nos. for DAQ requirement -2 |
| 2     | Signal Type                                       | To support Bridge configuration                                |
| 3     | Type of ADC                                       | Delta-Sigma with analog pre filtering                          |
| 4     | ADC Resolution                                    | 16 bits or better  |
| 5     | Max. data rate range by internal master time base | 50Ks/s or better   |
| 6     | Signal Input Range                                | 0 to 25 mV/V   |
| 7     | Accuracy  | 100 ppm or better  |
| 8     | Overvoltage protection                            | 30 V between any two pins                                      |
| 9     | Common-mode voltage, all signals to earth ground  | ±60 VDC  |
| 10    | Isolation channel-to-earth ground                 | 60 VDC   |
| 11    | Operating temperature                             | 10 °C to 70 °C   |
| 13    | Operational Shock                                 | 30 g, 11 ms half-sine  |
| 15    | Document from Vendor                              | OEM Authorization Certificate                                  |

### 3.2.3 Thermocouple Module

| SL.NO | DEVICE PARAMETERS                     | REQUIRED SPECIFICATION   |
|-------|---------------------------------------|--|
| 1     | No. of isolated Thermocouple Channels | 4 nos. for DAQ requirement -1<br>4 nos. for DAQ requirement -2 |
| 2     | Type of ADC                           | Delta-Sigma  |
| 3     | ADC Resolution                        | 16 bits or better  |
| 4     | Sampling rate                         | 1Ks/s/ch or better   |
| 5     | Voltage measurement range             | 0 to 75 mV   |
| 6     | Temperature measurement ranges        | Temperature ranges defined by NIST (J, K thermocouple types)   |

|    |                                   |                                |
|----|-----------------------------------|--------------------------------|
| 7  | Temperature Measurement Accuracy  | $\leq 0.05$ deg C              |
| 8  | Overvoltage protection            | $\pm 30$ V between TC+ and TC- |
| 9  | Isolation channel-to-earth ground | 60 VDC                         |
| 10 | Operating temperature             | 10 °C to 70 °C                 |
| 12 | Operating Shock                   | 30 g, 11 ms half-sine          |
| 14 | Document from Vendor              | OEM Authorization Certificate  |

### 3.2.4 RTD Module

| SL.NO | DEVICE PARAMETERS                 | REQUIRED SPECIFICATION  |
|-------|-----------------------------------|---|
| 1     | No Of Channels                    | 4 nos. for DAQ requirement -1<br>4 nos. for DAQ requirement -2  |
| 2     | RTD                               | PT100 / PT 500  |
| 3     | Type of ADC                       | Delta-Sigma   |
| 4     | ADC Resolution                    | 16 bits or better   |
| 5     | Sampling mode                     | Scanned   |
| 6     | Isolation channel-to-earth ground | 250 Vrms  |
| 7     | Temperature Measurement range     | -100 °C to 800 °C   |
| 8     | Overvoltage                       | $\pm 30$ V between inputs   |
| 9     | Excitation Current                | 1 mA per channel  |
| 11    | Safety Certification              | IEC 61010-1, EN 61010-1   |
| 13    | Operational Shock                 | 30 g, 11 ms half-sine   |
| 14    | CE Compliance                     | <ul style="list-style-type: none"> <li>• 2014/35/EU; Low-Voltage Directive (safety)</li> <li>• 2014/30/EU; Electromagnetic Compatibility Directive (EMC)</li> </ul> |
| 15    | Document from Vendor              | OEM Authorization Certificate   |

### 3.3 Analog Output Modules

#### 3.3.1 Current Signal

| SL.NO | DEVICE PARAMETERS                 | REQUIRED SPECIFICATION   |
|-------|-----------------------------------|--|
| 1     | No of Channels                    | 8 nos. for DAQ requirement -1<br>8 nos. for DAQ requirement -2 |
| 3     | DAC Resolution                    | 16 bits or better  |
| 4     | Output Signal Range               | 4 to 20 mA   |
| 5     | Compliance voltage                | 12 V DC maximum  |
| 7     | Maximum load                      | 600 $\Omega$   |
| 8     | Power Supply                      | 9 V DC to 30 V DC  |
| 9     | Overvoltage protection            | $\pm 36$ V b/w AO-to-COM and Vsup-to-COM                       |
| 10    | Noise                             | 600 nA RMS or better   |
|       | Cross talk                        | -90 dB   |
| 11    | Isolation channel-to-earth ground | 60 VDC   |
| 12    | Operating temperature             | 10 $^{\circ}$ C to 70 $^{\circ}$ C                             |
| 13    | Operating Shock                   | 30 g, 11 ms half-sine  |
| 14    | Document from Vendor              | OEM Authorization Certificate                                  |

### 3.4 Digital Input and Output modules

| SL.NO                               | DEVICE PARAMETERS                           | REQUIRED SPECIFICATION   |
|-------------------------------------|---|--|
| 1                                   | <b>Digital Input</b>                        |  |
|                                     | No of Digital Input Channels                | 16 nos. for DAQ requirement -1<br>28 nos. for DAQ requirement -2 |
|                                     | Input Type                                  | Sinking  |
|                                     | Input Voltage range                         | 0 to 24 VDC  |
|                                     | Digital Logic Level                         |  |
|                                     | OFF State<br>Input Voltage<br>Input current | $\leq 5$ V<br>$\leq 150$ $\mu$ A                                 |
|                                     | ON State<br>Input Voltage<br>Input current  | $\geq 10$ V<br>$\geq 330$ $\mu$ A                                |
|                                     | Input Impedance                             | 30k $\Omega \pm 5\%$   |
|                                     | Update time                                 | < 10 $\mu$ s   |
|                                     | 2   | <b>Digital Output</b>  |
| No of Digital Output Channels       |   | 8 nos. for DAQ requirement -1<br>14 nos. for DAQ requirement -2  |
| Digital Output type                 |   | Sourcing   |
| External power supply voltage range |   | 6 VDC to 24 VDC  |
| Current per channel                 |   | 100 mA minimum (per channel)                                     |
| Update time                         | < 10 $\mu$ s                                |  |

|  |                                   |                               |
|--|-----------------------------------|-------------------------------|
|  | Isolation channel-to-earth ground | 60 VDC                        |
|  | Operating temperature             | 10 °C to 70 °C                |
|  | Operational Shock                 | 30 g, 11 ms half-sine         |
|  | Document from Vendor              | OEM Authorization Certificate |

### 3.5 DATA PROCESSING NODE, DISPLAY NODE AND PORTABLE SYSTEM

Two PCs are to be configured as display nodes and 2 PCs are configured for data processing node. One portable system is required for the remote configuration of the smart transmitters used in the facility.

#### 3.5.1 Configuration for Data processing nodes.

Quantity: 2Nos.

| SL.NO | DEVICE PARAMETERS | REQUIRED SPECIFICATION   |
|-------|-------------------|--|
| 1     | Processor         | Intel Core i7 12 <sup>th</sup> generation or better  |
| 2     | Operating System  | Windows 11   |
|       | RAM               | 64 GB DDR4 or better   |
| 3     | GPU               | Nvidia 16 GB or better   |
| 4     | Hard Disk         | Primary: minimum 1TB SSD<br>Secondary: 2TB Hard Disk   |
| 5     | Removable Media   | DVD-RW for all format  |
| 7     | I/O Ports         | 6 No's of USB 3.0; minimum 2 front side, 1 RJ-45 Gigabit Ethernet, 3.5mm Audio   |
| 8     | Monitor size      | 27" Monitor having resolution of 1920x1080 or better with Digital Input & Aspect Ratio 16:9 & built-in speaker                   |
| 9     | Display port      | Dual Display Ports (at least one VGA & one HDMI)   |
| 10    | Power Supply      | 230V AC, 50Hz. Indian standard   |
| 11    | OS                | 64 bit Windows 11 prof. or higher version preinstalled   |
| 12    | Accessories       | Connecting cables with Indian Standard plug tops.<br>Wireless Keyboard and Mouse<br>Microsoft professional Office 2021 or latest |

#### 3.5.2 Configuration for display nodes. ( Quantity: 2Nos.)

|               |   |
|---------------|---|
| Screen        | 27-inch or above, LED-backlit, Resolution 1920x1200                         |
| Processor     | Intel core i7 13th Gen processor  |
| Memory        | 16 GB DDR4 RAM or higher version  |
| Hard Disk     | 500GB SSD or higher   |
| Graphics      | Integrated HD Graphics  |
| Network       | 10 /100/1000 Ethernet controller in-built                                   |
| USB Ports     | USB 4 Nos; Minimum 2 ports in front side                                    |
| Optical Drive | 16x DVD +/- RW (Optional)   |
| OS            | 64 bit Windows 11 prof. or higher version                                   |
| Accessories   | Wireless Keyboard and Mouse<br>Microsoft professional Office 2021 or latest |

### 3.5.3 Specification for Remote configuration node

Quantity: 1 No.

|               |   |
|---------------|---|
| Screen        | 14-inch or above, LED-backlit, Resolution 1920×1200                         |
| Processor     | Intel core i7 12th Gen processor  |
| Memory        | 8 GB DDR5 RAM or higher version   |
| Hard Disk     | 500GB SSD or higher   |
| Graphics      | Graphics- 4 GB  |
| USB Ports     | USB 3.0<br>minimum 2 Nos  |
| Ethernet port | Required  |
| OS            | 64 bit Windows 11 prof. or higher version                                   |
| Accessories   | Wireless Keyboard and Mouse<br>Microsoft professional Office 2021 or latest |

### 3.5 19" Checkout Rack

- Size : 19 inch rack conforms to EIA 310 with minimum height-42U. Party can choose the height to properly place all the equipment in the rack with ensuring minimum gap between equipment for removal and maintenance
- Aluminium extruded frame along with side, top and bottom panels in steel.
- Lockable front door made of toughened tinted glass of 5 mm Thick. Steel frame of 18 Gauge CRCA sheet.
- Rear steel door to be provided with a lock facility made of 18 Gauge CRCA sheet
- Side panels with slam latches vented top cover made of 18 Gauge CRCA sheet.
- Base frame to be made up of 13 Gauge CRCA sheet
- 19" Mount for equipment mounting channels and support angles are to be made of 14 Gauge CRCA sheet
- Maximum Load rating of 500 kg.
- Cooling fans and trays (in a group of 4 fans, two sets per rank) to be provided.
- One No of AC mains distribution board with 5 Nos of 5A socket (Horizontal mounting to be provided).
- Vertical cable tray to be made up of polymide with cover to be provided.
- Internal lighting to be provided with On/Off Switch.
- Rollers to be provide at the bottom for moving the racks. The rollers should be lockable type for positioning the racks.
- Side panels, Top and Bottom panels and doors to be power coated EPOXY/Anti flame property specified in RAL 7035 grey.
- Frame to be made of Aluminium extrusions power coated specified in RAL 7037 Dark Grey.
- The cabinet shall be supplied with all necessary hardware and accessories with complete wiring.



### 3.6 Regulated DC Power Supply 24 VDC/5A - 8 nos.

| DEVICE PARAMETERS       | REQUIRED SPECIFICATION                                     |
|-------------------------|--|
| Item Description        | DC power supply  |
| Output                  | 24 V DC $\pm 20\%$ , Current rating 5 Amps.                |
| Line Regulation         | $\leq \pm 0.2\%$ (for $\pm 10\%$ change in supply voltage) |
| Load Regulation         | $\leq \pm 0.2\%$ from no load to full load                 |
| Ripple @ Noise          | $\leq 100\text{mVrms}$                                     |
| Over Voltage Protection | To be provided   |
| Current Limit(Overload) | To be provided   |
| Stability               | $\leq 0.1\%$ for eight hours                               |
| Operating Power         | 230V AC $\pm 10\%$ 50Hz                                    |
| Operating Temperature   | 0-50°C   |

### 3.7 ETHERNET SWITCHES & CABLE

#### Ethernet Switch

| DEVICE PARAMETERS      | REQUIRED SPECIFICATION   |
|------------------------|--|
| Type                   | Layer 2 Manageable switch                                      |
| Standards              | 802.3 Ethernet, 802.3u Fast Ethernet, 802.3ab Gigabit Ethernet |
| No of Ports            | 8 Ports  |
| Form factor            | Rack mount   |
| Network media          | UTP cable  |
| Switching capacity     | 10 Gbps or higher  |
| Transmission method    | Store and forward  |
| Packet forwarding rate | 14 Mbps or higher  |
| Power supply           | 24V DC/ 230 V+ 10%AC, 50+1Hz                                   |

#### Ethernet Cable

| DEVICE PARAMETERS     | REQUIRED SPECIFICATION |
|-----------------------|------------------------|
| Category              | CAT5/ CAT6             |
| Type                  | Stranded and Shielded  |
| Wire Gauge            | 24 AWG                 |
| Cable impedance       | 100 $\Omega$           |
| Operating temperature | 0°C to 50°C            |
| Connector             | RJ 45                  |

### 3.8 Multipin Connector

| DEVICE PARAMETERS      | REQUIRED SPECIFICATION                    |
|------------------------|---|
| Contacts               | Male and Female Contacts                  |
| Type                   | Crimp                                     |
| Contact material       | Copper alloy- hard gold plated Au over Ni |
| Gold plating thickness | 0.8µm(min)                                |
| Ni thickness           | 2 µm(min)                                 |
| Contact size           | 18 AWG or 20 AWG                          |
| Working current        | 5 A                                       |
| Working voltage        | 300 V                                     |
| Contact resistance     | ≤4 milli ohm                              |

### 3.9 Relay Interface Module

| DEVICE PARAMETERS                        | REQUIRED SPECIFICATION   |
|--|--|
| Type                                     | Electro Mechanical moulded Relay   |
| Operation voltage                        | 24 V DC  |
| Nominal input current                    | ≤25mA  |
| No. of poles                             | 2 Pole [ NO, COM, NC ]   |
| construction                             | Supply status indication LED , Freewheeling diode and Reverse polarity protection diodes shall be assembled as integral part of the socket |
| Limiting continuous current              | 6 amps   |
| Power rating (ohmic load)                | ≥140 W   |
| Contact material                         | Au Ni /Ag Alloy  |
| Mechanical life                          | ≥ 1×10 <sup>7</sup> cycles   |
| Response time                            | ≤ 20 ms  |
| Release time                             | ≤ 10 ms  |
| Ambient temperature range                | Upto 60°C  |
| Type of connection                       | Screw connection   |
| Identification label                     | Provision is to be provided  |
| Removal of relay                         | Provision is to be remove the relay from socket  |
| Standards/ regulations                   | IEC 60 664/IEC 60 664 A/<br>/ IEC 60695-2-11   |
| Approvals/ Certification and certificate | Relay modules shall have approval confirms to UL508/ EN61810- 1/GL standard / IEC 61810-1  |

### 3.10 LaserJet Multifunction Printer

| DEVICE PARAMETERS                 | REQUIRED SPECIFICATION   |
|-----------------------------------|--|
| Type                              | Multifunction Black and White Printer  |
| Standard Function                 | Print, Copy, Scan  |
| Print Speed                       | > 20 ppm   |
| Processor                         | 1GHz Dual Core   |
| Memory                            | 512MB  |
| Copy and Print Resolution         | minimum 600 X 600 dpi  |
| First copy-out and print-out time | < 10 sec   |
| Duty Cycle                        | minimum up to 2000 pages per month   |
| Connectivity                      | 1. High-Speed USB 2.0 (Type A)<br>2. High-Speed USB 2.0 (Type B)<br>3. Ethernet 10/100 BaseTX  |
| Paper Output                      | Automatic Two sided printing available   |
| Paper size                        | A3, A4   |
| Paper Tray                        | Separate Tray for A3 and A4 paper with capacity of at least 200 papers in each Tray  |
| Power Input                       | Voltage : 220-240V AC<br>Frequency: 47-63 Hz   |
| OS support                        | Support for a wide variety of industry standard operating systems including Windows 7 32 bit and 64 bit, windows Vista 32 bit and 64 bit, windows 8 64 bit, windows XP 32 bit, Apple Mac, OS/2, UNIX and Linux |
| Warranty                          | Minimum 1 Year   |

Note: Installation and Demonstration of printer function at Purchaser's site. Software CDs and user manuals shall be supplied for the printer.

#### 4. Integration and Wiring

- a) Instrumentation Rack- 19" to be used to house the entire data acquisition and control unit including power supplies, relays etc
- b) Wiring for different voltage signals and different functions shall be terminated separately on dedicated terminal strips.
- c) Wiring shall be accomplished with flexible stranded tinned copper wires sized 20/22 AWG, PTFE Shielded cable with multipin connectors for termination.
- d) Wires shall be hosed in plastic raceways of suitable dimensions to accommodate system cables, I/O signal cable etc. having 20% spare space for future expansion.
- e) Terminations, cables, wiring, components shall be properly tagged with ferruling at both sides of the termination. Terminal strips shall be of adequate size min 1.5 mm<sup>2</sup>
- f) The system cabinet shall have two separate grounding bars, one for safety purposes (power earth) and the other one for operation purposes (Instrumentation earth).

- g) Required electrical, mechanical accessories & consumables like fuses, terminals, DIN rails, cable manager, cable harnessing materials etc should be supplied.

**Notes:** This specification provides the minimum requirement of the system but it does not relieve the supplier from his responsibilities for completeness of the system concerning the design, the reliability and the safe operation of the supplied equipment.

## **5. GENERAL SPECIFICATION OF DATA ACQUISITION AND CONTROL SOFTWARE**

The software should be developed in latest version of LabVIEW with following feature.

- The vendor has to supply the complete data acquisition, control, storage, and analysis software package with necessary source code.
- Supply of source code for data acquisition system application program development with details for modification during future requirement.

### **5.1 Login**

The software should have two levels of security namely Administrator and Operator. The administrator should have access to all the features provided by the software and operator's accessibility should be limited to conducting the tests.

### **5.2 Configuration Settings**

- a. The acquisition software shall be capable of scanning the selected user required channels.
- b. Also the per channel selection of legend, description, range selection shall be possible.
- c. Logging of set configurations in notepad or in spreadsheet format.

### **5.3 Acquisition Software**

- a. The software should be capable of entering channel wise legends, description, units and first & fourth order constants for Engineering Unit (EU) conversion.
- b. Data from each channel should be acquired by selecting the engineering unit. . The data should be displayed in two different PC's in the control room. The control valves and solenoid valves should be controlled in the open loop/closed loop using necessary setting in the software.
- c. The acquisition software shall be capable of being operated with acquisition ON/OFF & file writing ON/OFF features. Data to be stored in controller hard disk in text format.
- d. Interlock, Auto and Abort sequence, Process variable measurement, Data storage, manual /auto operation, emergency shutdown etc. shall be considered. Event acquisition & auto sequence command generation are required.
- e. All the data should be logged as per the instruction from the PC with necessary command. All necessary information should be stored while logging such as Run number, Start time of the test etc.

### **5.4 Online Display and Off-Line Analysis**

- a. Online monitoring (Data and Trend graph display) of process parameters during preparation and test phase. Online display to be provided in graphical and numerical format. Feedback status of all valves is to be displayed.
- b. The engineering unit (EU) or voltage selection shall be made available in the numerical display and graphical display.
- c. The graphical display shall start with trigger signal or based on time from an ethernet based countdown clock.

- d. The graphical display shall have different scales user selectable for each parameter and shall have four parameters per screen. The different pages change over can be based on time reference or by keyboard control. The required parameters for display shall be entered in a text file.
- e. The numerical and graphical display shall have the option for color change when threshold limits are not met.
- f. Real time performance calculation with on-line data.

### **5.5 Offline Processing**

- a. Offline processing of selected channels in EU or Voltage with selectable averaging, printing intervals, time offset correction etc. The file shall have optional header and stored in DAT format.
- b. Offline plotting of selected channels in EU or Voltage with optional headers.
- c. Mathematical and statistic analysis tools like Time Domain plot, Average, Min, Max, curve fitting for analyzing offline processed data.

### **5.6 Special Conditions**

- a. Detailed software specification should be prepared after the detailed system study and the software specification should be submitted to LPSC and only after the approval, the party should start the necessary coding for our application.
- b. Source code for the software, operation and maintenance of the software should be provided along with the software.
- c. Source code should have provision for future up gradation such as increasing the channel count.
- d. The software should be modular and documentation should be provided for the same in detail.
- e. The software shall be accepted only after necessary satisfactory test run at our site and the party should be responsible for correcting any bug detected in the software within one year from date of acceptance of the software by LPSC.
- f. Vendor shall be responsible for chain checking which shall include checking of the configuration, interconnection to DAS and display node.
- g. Provision should be available in the software for checking the functional performance of all elements in the chain.
- h. Event data Acquisition at every 20 msec and analog acquisition sampling rate can be user selectable.
- i. Data updating in display and graph within 1 sec.
- j. Auto sequence command generation with 20 msec interval.
- k. There should be provision for calibration of measurement chain and also storage of sensor constant.
- l. Also provide provision for manual and auto mode operation.
- m. The supplier shall provide adequate training for the source code to department Engineers (2 persons), during control system and data acquisition system integration and software development at LPSC, Valiamala.
- n. The training shall be so organized for control system and data acquisition system to provide complete understanding of the functions of the system, overall system concepts and routine operation for maintenance of the system and application software development. It is essential that all the system and other required document shall be available before commencement of training.

## 6. FINAL COMMISSIONING AND VALIDATION

After completing all the installation and software development activities party has to do the chain calibration, verification and validation of all measurement and control channels. Report of the same shall be submitted. The format of the report will finalise in the detailed engineering phase. Following check has to be done in Data Acquisition System

- Integrated System Performance
- Evaluation tests
  - Functional check
  - Linearity check
  - Gain accuracy
  - Filter performance evaluation
  - Time accuracy check
  - Cross talk check
  - A.C signal check
  - Over voltage check
  - Stability check
- Data Acquisition System Sampling rate with full channel capacity.
- CMRR, Isolation and CMV checks.
- Error diagnostics of the network failure, system failure, input card failure.
- Display updating Test.
- Data storage test (continuous storage for 5 hours with selectable sampling rate).
- Any other mutually agreed test.

## 7. DETAIL ENGINEERING

The detailed engineering shall be done on the basis of finally agreed Data Acquisition and display philosophy and process Input list. Hardware shall be selected accordingly. The quantity and model number for hardware and software version to be provided. The following documents shall be prepared and submitted by the party for the approval from the Department during detailed engineering.

- Instrument rack General Assembly diagrams
- Instrumentation rack wiring diagram
- Equipment earthing scheme/layout inside control room
- Data Acquisition system:
  - ❖ System Architecture & Configuration drawing
  - ❖ Wiring diagram with connector pin details
  - ❖ Interconnections diagram including communication links
  - ❖ Electrical power supply distribution diagram
  - ❖ Software life cycle model followed for software development should be mentioned.
  - ❖ Error budget calculation sheet for individual cards to be provided
- Quantity Estimation of items and its specifications
- Testing and Evaluation plan
- Inspection & Quality assurance plan
- Chain checking procedures.

Supplier shall supply detailed engineering documents (2 copies) with required specifications and drawing as Hard & Soft copies to the purchaser for review and approval. Only the approved configuration by the purchaser has to be followed for all commissioning activities.